# 505480916 05/16/2019

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5527720

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
HWANG YEON KIM	05/09/2019

## **RECEIVING PARTY DATA**

Name:	SK HYNIX INC.	
Street Address:	2091, GYEONGCHUNG-DAERO, BUBAL-EUP, GYEONGGI-DO	
City:	ICHEON	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	17336	

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16414684

### **CORRESPONDENCE DATA**

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 4253483500
Email: amf@ampacc.com
Correspondent Name: AMPACC LAW GROUP
Address Line 1: 6100 219TH ST. SW

Address Line 2: SUITE 580

Address Line 4: MOUNTLAKE TERRACE, WASHINGTON 98043

ATTORNEY DOCKET NUMBER:	100SK0833US
NAME OF SUBMITTER:	AMY FLORES
SIGNATURE:	/Amy Flores/
DATE SIGNED:	05/16/2019

**Total Attachments: 1** source=41A9600#page1.tif

PATENT 505480916 REEL: 049216 FRAME: 0638

Attorney Docket No. 100SK0833US Client Reference No.: PTPUS201800858

### ASSIGNMENT OF PATENT APPLICATION

WHEREAS, the below named individual(s), hereinafter referred to as "Assignors," are the inventor(s) of the invention described and set forth in the below-identified application for United States Letters Patent:

Title of Invention:

FLECTRONIC DEVICE AND METHOD FOR

FABRICATING THE SAME

Filing Date:

May 16, 2019

Application No.:

16/414.684

WHEREAS SK hyaix Inc. of 2091, Gyeongchung-daero, Bubal-cub, Icheon-si, Gyeonegi-do, Republic of Korea, herematics referred to as "ASSIGNEE," is desirous of acquiring ASSIGNORS' interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN. Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignors, Assignors have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said Assignees, and Assignees' successors and assigns, all their right, title and interest in and to the said invention and application including any corresponding foreign application, and in and to any Letters Patent which may hereafter be granted on the same in the United States and any corresponding foreign application, the said interest to be held and enjoyed by said Assignoes as fully and exclusively as it would have been held and enjoyed by said Assignors had this Assignment and transfer not been made, to the full end and term of any Letters Patent whileh may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, ressue, prolongation or extension thereof

Assigners further agree that they will, without charge to Assigner, but at Assigner's expense, cooperate with Assignite in the prosecution of said application and/or applications, execute verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assumee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in Assignee, or Assignee's successors and assigns.

Assignors hereby authorize and request AMPACC Law Group, PLLC, 6100 219th Street SW. Suite 580, Mountlake Terrace, WA 98043, to insert herein above the application number and filing date of said application when known.

IN TESTIMONY WHERFOF, Assignors have signed their names on the dates indicated.

Name Hwang Yeon KIM

58.000

PATENT

3189 94 Obelisk Pi

REEL: 049216 FRAME: 0639